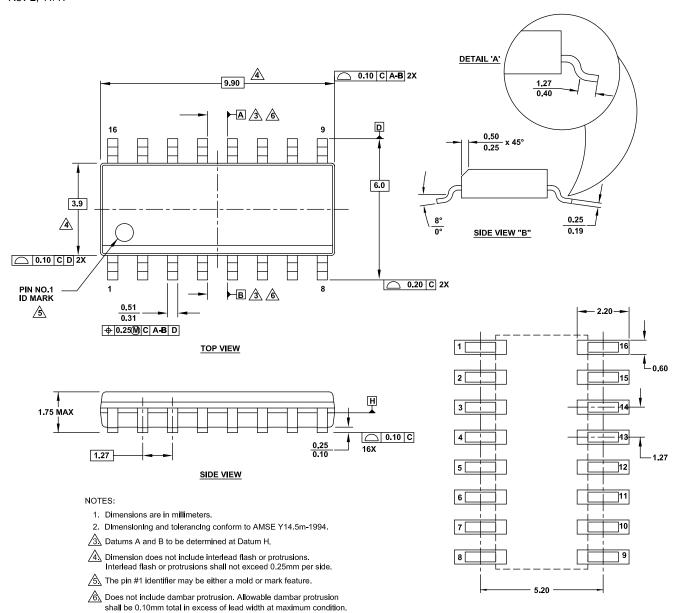
Plastic Packages for Integrated Circuits

1. Package Outline Drawing

M16.15 (JEDEC MS-012-AC ISSUE C)
16 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE
Rev 2, 11/17

7. Reference to JEDEC MS-012-AC



TYPICAL RECOMMENDED LAND PATTERN

